

# SN54AC244, SN74AC244 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCAS514E – JUNE 1995 – REVISED OCTOBER 2003

- 2-V to 6-V  $V_{CC}$  Operation
- Inputs Accept Voltages to 6 V
- Max  $t_{pd}$  of 7.5 ns at 5 V

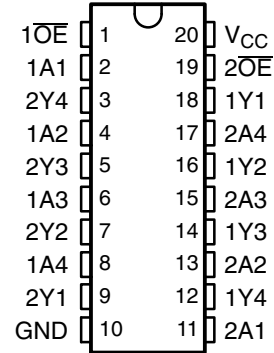
## description/ordering information

These octal buffers and line drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

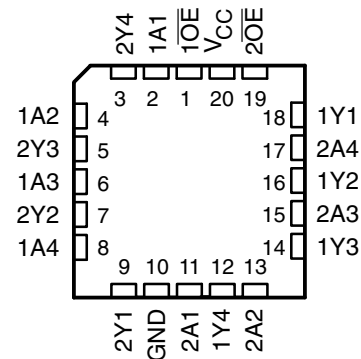
The 'AC244 devices are organized as two 4-bit buffers/drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes noninverted data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## SN54AC244 . . . J OR W PACKAGE SN74AC244 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



## SN54AC244 . . . FK PACKAGE (TOP VIEW)



## ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE†   |               | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|------------|---------------|--------------------------|---------------------|
| –40°C to 85°C  | PDIP – N   | Tube          | SN74AC244N               | SN74AC244N          |
|                | SOIC – DW  | Tube          | SN74AC244DW              | AC244               |
|                |            | Tape and reel | SN74AC244DWR             |                     |
|                | SOP – NS   | Tape and reel | SN74AC244NSR             | AC244               |
|                | SSOP – DB  | Tape and reel | SN74AC244DBR             | AC244               |
|                | TSSOP – PW | Tube          | SN74AC244PW              | AC244               |
| Tape and reel  |            | SN74AC244PWR  |                          |                     |
| –55°C to 125°C | CDIP – J   | Tube          | SNJ54AC244J              | SNJ54AC244J         |
|                | CFP – W    | Tube          | SNJ54AC244W              | SNJ54AC244W         |
|                | LCCC – FK  | Tube          | SNJ54AC244FK             | SNJ54AC244FK        |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

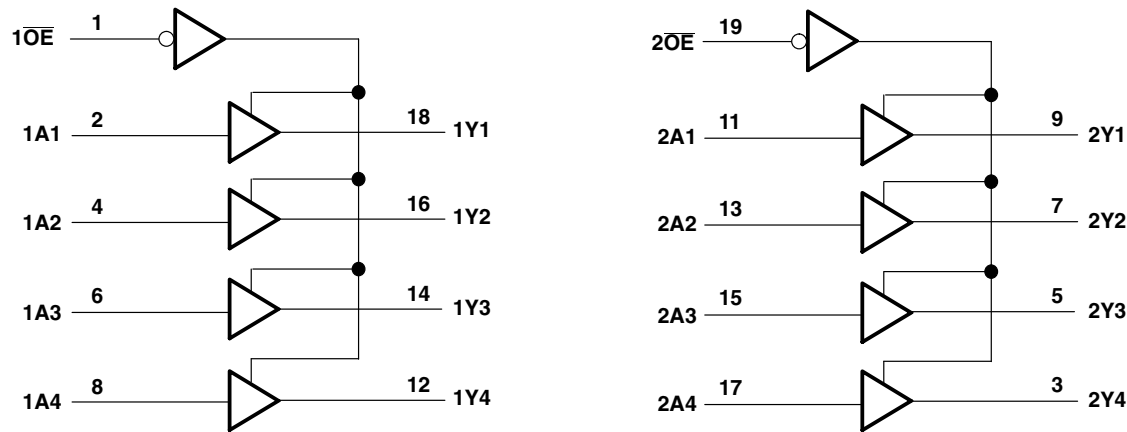
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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

**FUNCTION TABLE**  
 (each buffer)

| INPUTS |   | OUTPUT |
|--------|---|--------|
| OE     | A | Y      |
| L      | H | H      |
| L      | L | L      |
| H      | X | Z      |

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                |                            |
|----------------------------------------------------------------|----------------------------|
| Supply voltage range, $V_{CC}$                                 | –0.5 V to 7 V              |
| Input voltage range, $V_I$ (see Note 1)                        | –0.5 V to $V_{CC} + 0.5$ V |
| Output voltage range, $V_O$ (see Note 1)                       | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )  | ±20 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) | ±20 mA                     |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )     | ±50 mA                     |
| Continuous current through $V_{CC}$ or GND                     | ±200 mA                    |
| Package thermal impedance, $\theta_{JA}$ (see Note 2):         |                            |
| DB package                                                     | 70°C/W                     |
| DW package                                                     | 58°C/W                     |
| N package                                                      | 69°C/W                     |
| NS package                                                     | 60°C/W                     |
| PW package                                                     | 83°C/W                     |
| Storage temperature range, $T_{stg}$                           | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 2. The package thermal impedance is calculated in accordance with JESD 51-7.

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## recommended operating conditions (see Note 3)

|                     |                                    |                         | SN54AC244 |          | SN74AC244 |          | UNIT |
|---------------------|------------------------------------|-------------------------|-----------|----------|-----------|----------|------|
|                     |                                    |                         | MIN       | MAX      | MIN       | MAX      |      |
| $V_{CC}$            | Supply voltage                     |                         | 2         | 6        | 2         | 6        | V    |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 3\text{ V}$   | 2.1       |          | 2.1       |          | V    |
|                     |                                    | $V_{CC} = 4.5\text{ V}$ | 3.15      |          | 3.15      |          |      |
|                     |                                    | $V_{CC} = 5.5\text{ V}$ | 3.85      |          | 3.85      |          |      |
| $V_{IL}$            | Low-level input voltage            | $V_{CC} = 3\text{ V}$   |           | 0.9      |           | 0.9      | V    |
|                     |                                    | $V_{CC} = 4.5\text{ V}$ |           | 1.35     |           | 1.35     |      |
|                     |                                    | $V_{CC} = 5.5\text{ V}$ |           | 1.65     |           | 1.65     |      |
| $V_I$               | Input voltage                      |                         | 0         | $V_{CC}$ | 0         | $V_{CC}$ | V    |
| $V_O$               | Output voltage                     |                         | 0         | $V_{CC}$ | 0         | $V_{CC}$ | V    |
| $I_{OH}$            | High-level output current          | $V_{CC} = 3\text{ V}$   |           | –12      |           | –12      | mA   |
|                     |                                    | $V_{CC} = 4.5\text{ V}$ |           | –24      |           | –24      |      |
|                     |                                    | $V_{CC} = 5.5\text{ V}$ |           | –24      |           | –24      |      |
| $I_{OL}$            | Low-level output current           | $V_{CC} = 3\text{ V}$   |           | 12       |           | 12       | mA   |
|                     |                                    | $V_{CC} = 4.5\text{ V}$ |           | 24       |           | 24       |      |
|                     |                                    | $V_{CC} = 5.5\text{ V}$ |           | 24       |           | 24       |      |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |                         |           | 8        |           | 8        | ns/V |
| $T_A$               | Operating free-air temperature     |                         | –55       | 125      | –40       | 85       | °C   |

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN54AC244, SN74AC244

## OCTAL BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS                                                                                     | V <sub>CC</sub>                         | T <sub>A</sub> = 25°C |     |       | SN54AC244 |     | SN74AC244 |      | UNIT |
|-----------------|-----------------------------------------------------------------------------------------------------|-----------------------------------------|-----------------------|-----|-------|-----------|-----|-----------|------|------|
|                 |                                                                                                     |                                         | MIN                   | TYP | MAX   | MIN       | MAX | MIN       | MAX  |      |
| V <sub>OH</sub> | I <sub>OH</sub> = –50 µA                                                                            | 3 V                                     | 2.9                   |     |       | 2.9       |     | 2.9       |      | V    |
|                 |                                                                                                     | 4.5 V                                   | 4.4                   |     |       | 4.4       |     | 4.4       |      |      |
|                 |                                                                                                     | 5.5 V                                   | 5.4                   |     |       | 5.4       |     | 5.4       |      |      |
|                 | I <sub>OH</sub> = –12 mA                                                                            | 3 V                                     | 2.56                  |     |       | 2.4       |     | 2.46      |      |      |
|                 | I <sub>OH</sub> = –24 mA                                                                            | 4.5 V                                   | 3.86                  |     |       | 3.7       |     | 3.76      |      |      |
|                 |                                                                                                     | 5.5 V                                   | 4.86                  |     |       | 4.7       |     | 4.76      |      |      |
|                 | I <sub>OH</sub> = –50 mA <sup>†</sup>                                                               | 5.5 V                                   |                       |     |       | 3.85      |     |           |      |      |
| V <sub>OL</sub> | I <sub>OL</sub> = 50 µA                                                                             | 3 V                                     |                       |     | 0.1   |           | 0.1 |           | 0.1  | V    |
|                 |                                                                                                     | 4.5 V                                   |                       |     | 0.1   |           | 0.1 |           | 0.1  |      |
|                 |                                                                                                     | 5.5 V                                   |                       |     | 0.1   |           | 0.1 |           | 0.1  |      |
|                 | I <sub>OL</sub> = 12 mA                                                                             | 3 V                                     |                       |     | 0.36  |           | 0.5 |           | 0.44 |      |
|                 | I <sub>OL</sub> = 24 mA                                                                             | 4.5 V                                   |                       |     | 0.36  |           | 0.5 |           | 0.44 |      |
|                 |                                                                                                     | 5.5 V                                   |                       |     | 0.36  |           | 0.5 |           | 0.44 |      |
|                 | I <sub>OL</sub> = 50 mA <sup>†</sup>                                                                | 5.5 V                                   |                       |     |       | 1.65      |     |           |      |      |
| I <sub>I</sub>  | Data inputs                                                                                         | V <sub>I</sub> = V <sub>CC</sub> or GND |                       |     | ±0.1  |           | ±1  |           | ±1   | µA   |
|                 | Control inputs                                                                                      | V <sub>I</sub> = V <sub>CC</sub> or GND |                       |     | ±0.1  |           | ±1  |           | ±1   |      |
| I <sub>OZ</sub> | V <sub>O</sub> = V <sub>CC</sub> or GND,<br>V <sub>I(OE)</sub> = V <sub>IL</sub> or V <sub>IH</sub> | 5.5 V                                   |                       |     | ±0.25 |           | ±5  |           | ±2.5 | µA   |
| I <sub>CC</sub> | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0                                         | 5.5 V                                   |                       |     | 4     |           | 80  |           | 40   | µA   |
| C <sub>i</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND                                                             | 5 V                                     |                       | 2.5 |       |           |     |           |      | pF   |

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

switching characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | T <sub>A</sub> = 25°C |     |      | SN54AC244 |      | SN74AC244 |      | UNIT |
|------------------|--------------|-------------|-----------------------|-----|------|-----------|------|-----------|------|------|
|                  |              |             | MIN                   | TYP | MAX  | MIN       | MAX  | MIN       | MAX  |      |
| t <sub>PLH</sub> | A            | Y           | 2                     | 6.5 | 9    | 1         | 12.5 | 1.5       | 10   | ns   |
| t <sub>PHL</sub> |              |             | 2                     | 6.5 | 9    | 1         | 12   | 2         | 10   |      |
| t <sub>PZH</sub> | OE           | Y           | 2                     | 6   | 10.5 | 1         | 11.5 | 1.5       | 11   | ns   |
| t <sub>PZL</sub> |              |             | 2.5                   | 7.5 | 10   | 1         | 13   | 2         | 11   |      |
| t <sub>PHZ</sub> | OE           | Y           | 3                     | 7   | 10   | 1         | 12.5 | 1.5       | 10.5 | ns   |
| t <sub>PLZ</sub> |              |             | 2.5                   | 7.5 | 10.5 | 1         | 13   | 2.5       | 11.5 |      |

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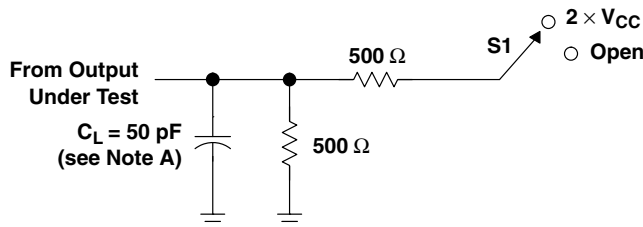
switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM<br>(INPUT)        | TO<br>(OUTPUT) | $T_A = 25^\circ\text{C}$ |     |     | SN54AC244 |      | SN74AC244 |     | UNIT |
|-----------|------------------------|----------------|--------------------------|-----|-----|-----------|------|-----------|-----|------|
|           |                        |                | MIN                      | TYP | MAX | MIN       | MAX  | MIN       | MAX |      |
| $t_{PLH}$ | A                      | Y              | 1.5                      | 5   | 7   | 1         | 9.5  | 1         | 7.5 | ns   |
| $t_{PHL}$ |                        |                | 1.5                      | 5   | 7   | 1         | 9    | 1         | 7.5 |      |
| $t_{PZH}$ | $\overline{\text{OE}}$ | Y              | 1.5                      | 5   | 7   | 1         | 9    | 1.5       | 8   | ns   |
| $t_{PZL}$ |                        |                | 1.5                      | 5.5 | 8   | 1         | 10.5 | 1.5       | 8.5 |      |
| $t_{PHZ}$ | $\overline{\text{OE}}$ | Y              | 2.5                      | 6.5 | 9   | 1         | 10.5 | 1         | 9.5 | ns   |
| $t_{PLZ}$ |                        |                | 2                        | 6.5 | 9   | 1         | 11   | 2         | 9.5 |      |

operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

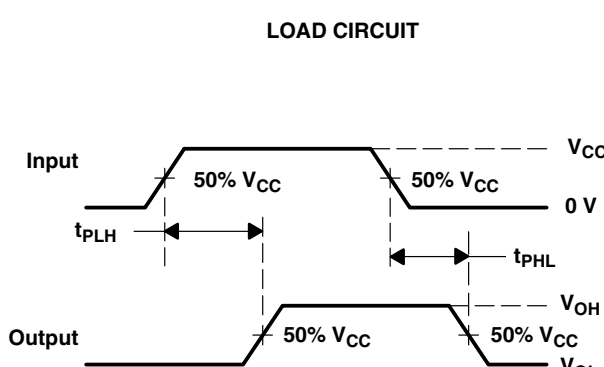
| PARAMETER                                                | TEST CONDITIONS                           | TYP | UNIT |
|----------------------------------------------------------|-------------------------------------------|-----|------|
| $C_{pd}$ Power dissipation capacitance per buffer/driver | $C_L = 50\text{ pF}$ , $f = 1\text{ MHz}$ | 45  | pF   |

## PARAMETER MEASUREMENT INFORMATION

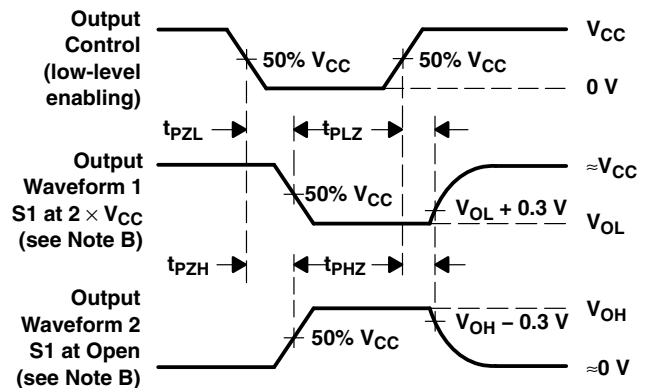


| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | Open              |

LOAD CIRCUIT



VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\text{ }\Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .
  - The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|----------------------------------------|-------------------------|
| 5962-87552012A   | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type   | -55 to 125   | 5962-<br>87552012A<br>SNJ54AC<br>244FK | <a href="#">Samples</a> |
| 5962-8755201RA   | ACTIVE        | CDIP         | J                  | 20   | 1              | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | 5962-8755201RA<br>SNJ54AC244J          | <a href="#">Samples</a> |
| 5962-8755201SA   | ACTIVE        | CFP          | W                  | 20   | 1              | TBD                        | Call TI          | N / A for Pkg Type   | -55 to 125   | 5962-8755201SA<br>SNJ54AC244W          | <a href="#">Samples</a> |
| 5962-8755201VRA  | ACTIVE        | CDIP         | J                  | 20   | 20             | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | 5962-8755201VR<br>A<br>SNV54AC244J     | <a href="#">Samples</a> |
| 5962-8755201VSA  | ACTIVE        | CFP          | W                  | 20   | 1              | TBD                        | Call TI          | N / A for Pkg Type   | -55 to 125   | 5962-8755201VS<br>A<br>SNV54AC244W     | <a href="#">Samples</a> |
| SN74AC244DBLE    | OBSOLETE      | SSOP         | DB                 | 20   |                | TBD                        | Call TI          | Call TI              | -40 to 85    |                                        |                         |
| SN74AC244DBR     | ACTIVE        | SSOP         | DB                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DBRE4   | ACTIVE        | SSOP         | DB                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DBRG4   | ACTIVE        | SSOP         | DB                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DW      | ACTIVE        | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DWE4    | ACTIVE        | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DWG4    | ACTIVE        | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DWR     | ACTIVE        | SOIC         | DW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DWRE4   | ACTIVE        | SOIC         | DW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244DWRG4   | ACTIVE        | SOIC         | DW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244N       | ACTIVE        | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -40 to 85    | SN74AC244N                             | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|----------------------------------------|-------------------------|
| SN74AC244NE4     | ACTIVE        | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -40 to 85    | SN74AC244N                             | <a href="#">Samples</a> |
| SN74AC244NSR     | ACTIVE        | SO           | NS                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244NSRE4   | ACTIVE        | SO           | NS                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244NSRG4   | ACTIVE        | SO           | NS                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244PW      | ACTIVE        | TSSOP        | PW                 | 20   | 70             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244PWE4    | ACTIVE        | TSSOP        | PW                 | 20   | 70             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244PWG4    | ACTIVE        | TSSOP        | PW                 | 20   | 70             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244PWLE    | OBSOLETE      | TSSOP        | PW                 | 20   |                | TBD                        | Call TI          | Call TI              | -40 to 85    |                                        |                         |
| SN74AC244PWR     | ACTIVE        | TSSOP        | PW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244PWRE4   | ACTIVE        | TSSOP        | PW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SN74AC244PWRG4   | ACTIVE        | TSSOP        | PW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | AC244                                  | <a href="#">Samples</a> |
| SNJ54AC244FK     | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type   | -55 to 125   | 5962-<br>87552012A<br>SNJ54AC<br>244FK | <a href="#">Samples</a> |
| SNJ54AC244J      | ACTIVE        | CDIP         | J                  | 20   | 1              | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | 5962-8755201RA<br>SNJ54AC244J          | <a href="#">Samples</a> |
| SNJ54AC244W      | ACTIVE        | CFP          | W                  | 20   | 1              | TBD                        | Call TI          | N / A for Pkg Type   | -55 to 125   | 5962-8755201SA<br>SNJ54AC244W          | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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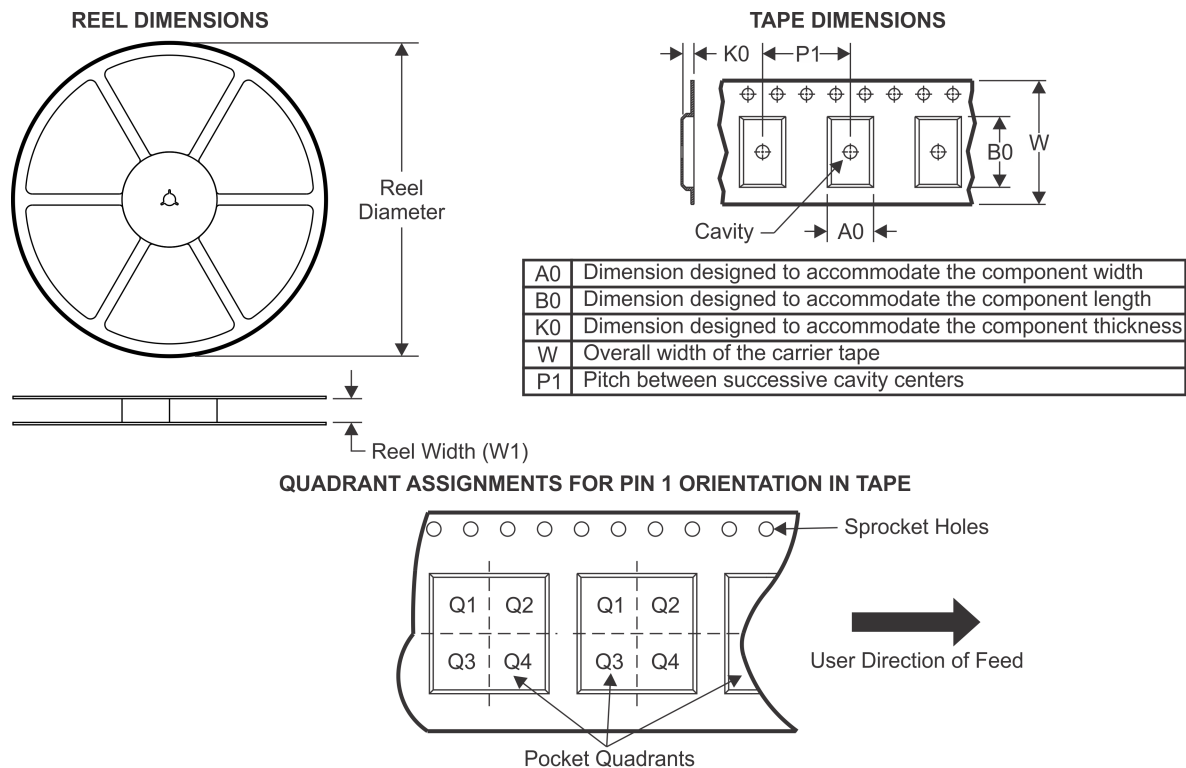
#### **OTHER QUALIFIED VERSIONS OF SN54AC244, SN54AC244-SP, SN74AC244 :**

- Catalog: [SN74AC244](#), [SN54AC244](#)
- Enhanced Product: [SN74AC244-EP](#), [SN74AC244-EP](#)
- Military: [SN54AC244](#)
- Space: [SN54AC244-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

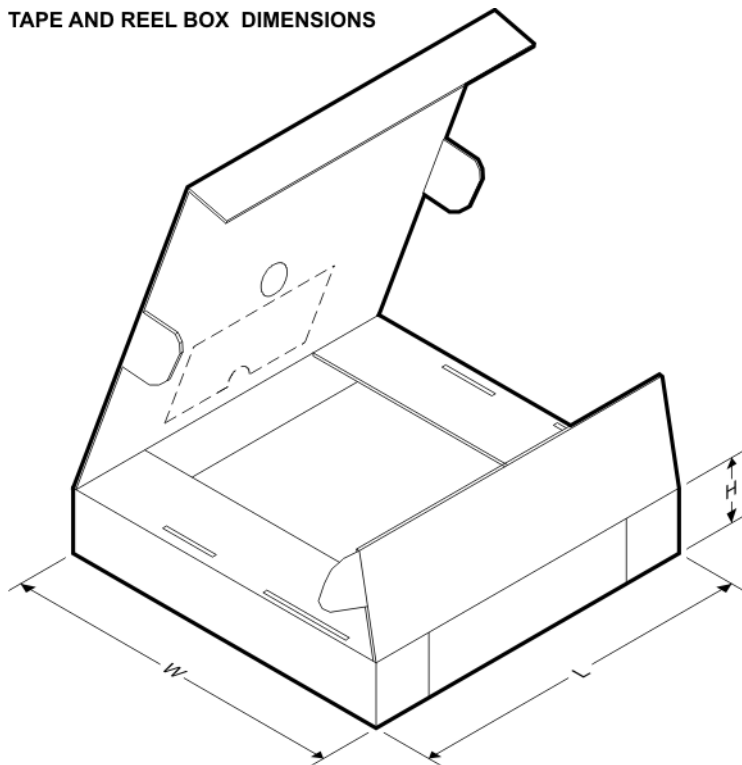
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AC244DBR | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |
| SN74AC244DWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74AC244NSR | SO           | NS              | 20   | 2000 | 330.0              | 24.4               | 8.2     | 13.0    | 2.5     | 12.0    | 24.0   | Q1            |
| SN74AC244PWR | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



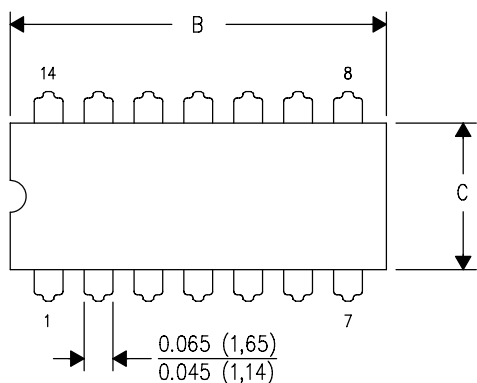
\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AC244DBR | SSOP         | DB              | 20   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74AC244DWR | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74AC244NSR | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74AC244PWR | TSSOP        | PW              | 20   | 2000 | 367.0       | 367.0      | 38.0        |

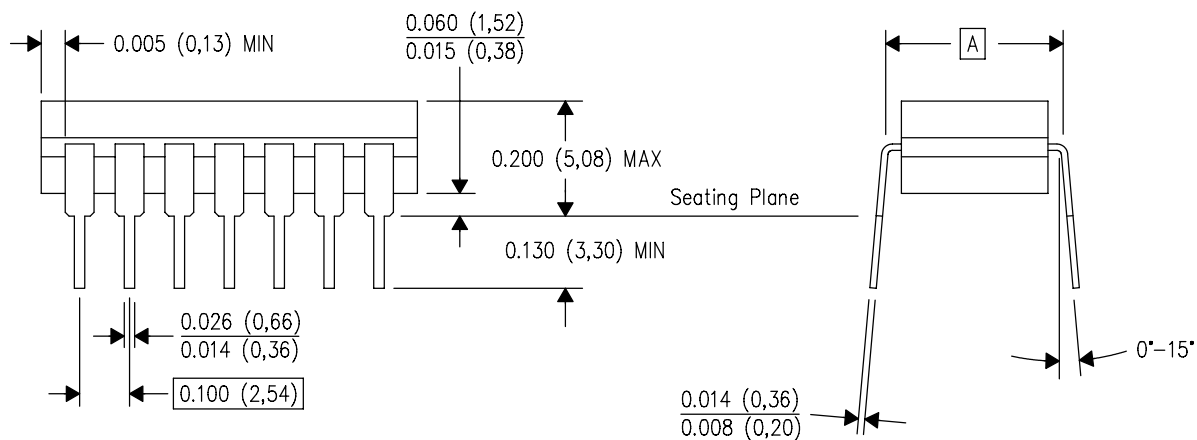
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |

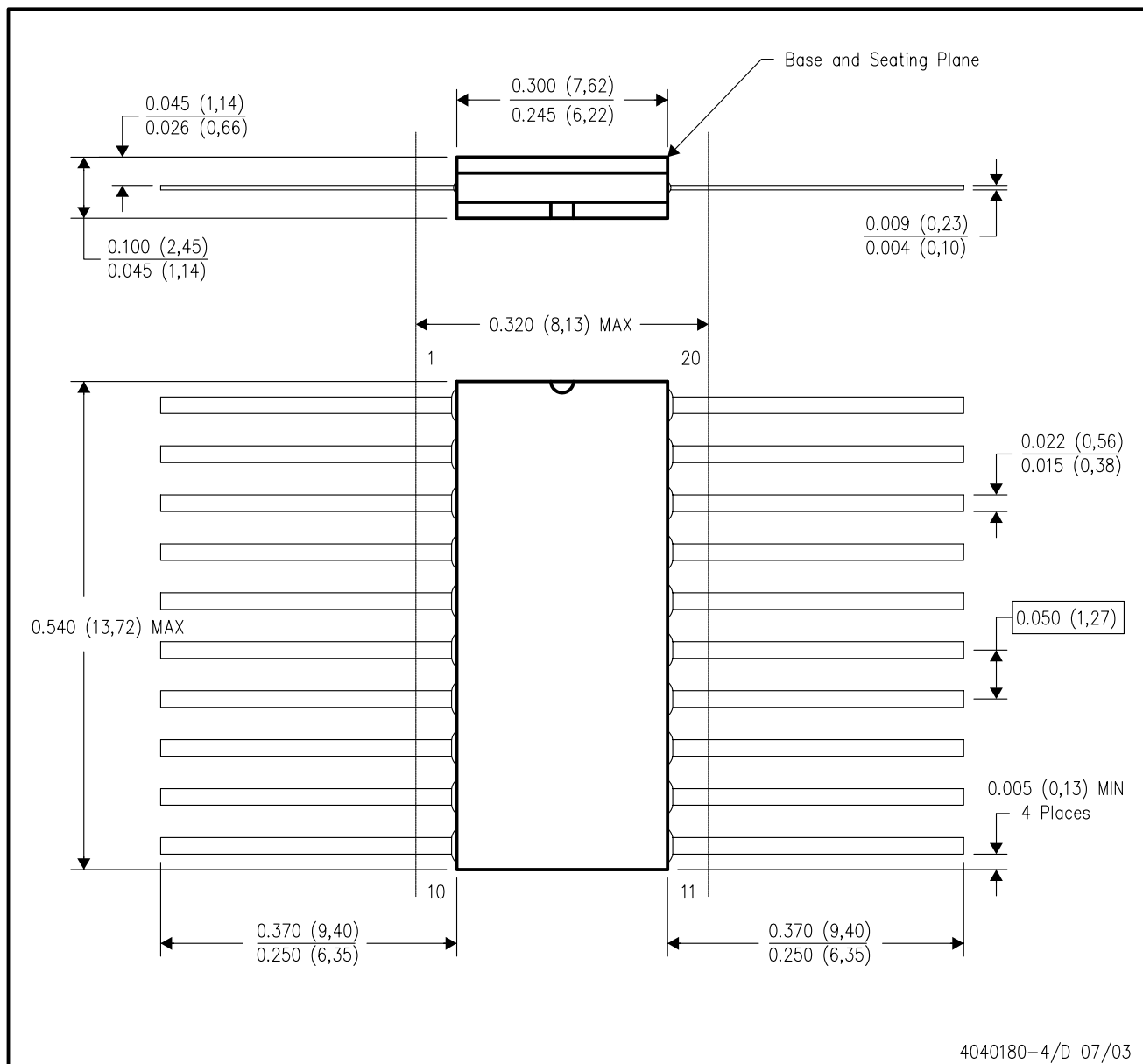


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK

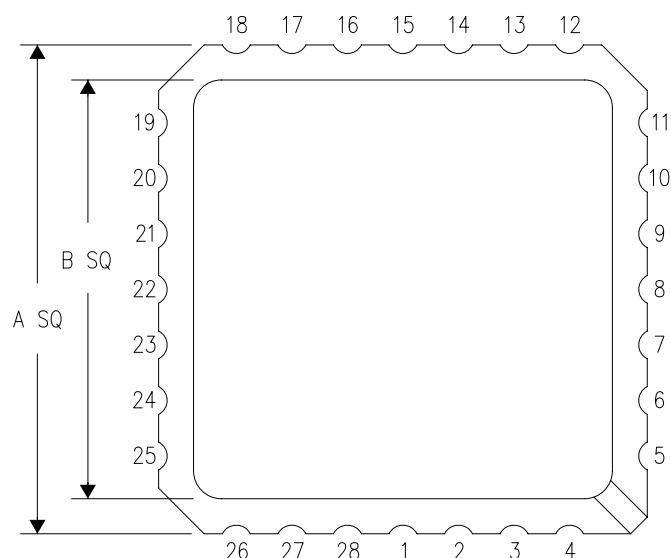


- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within Mil-Std 1835 GDFP2-F20

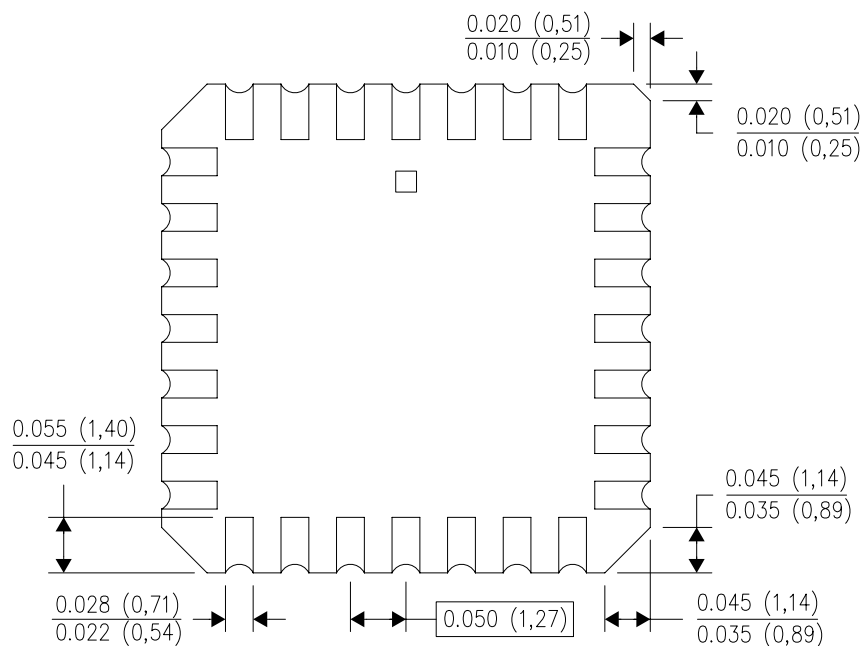
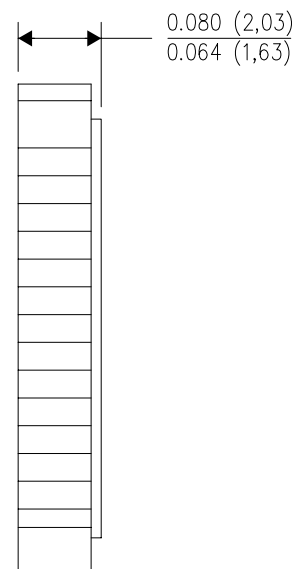
FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF<br>TERMINALS<br>** | A                |                  | B                |                  |
|---------------------------|------------------|------------------|------------------|------------------|
|                           | MIN              | MAX              | MIN              | MAX              |
| 20                        | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                        | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                        | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                        | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                        | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                        | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |



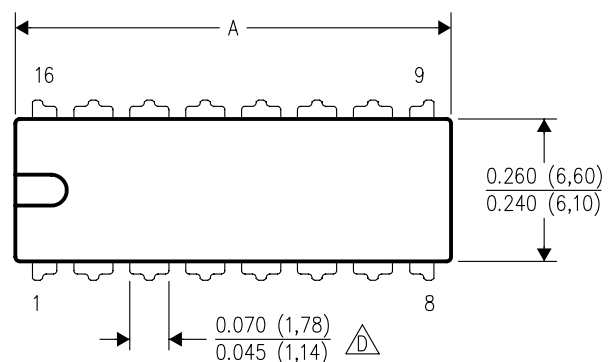
4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

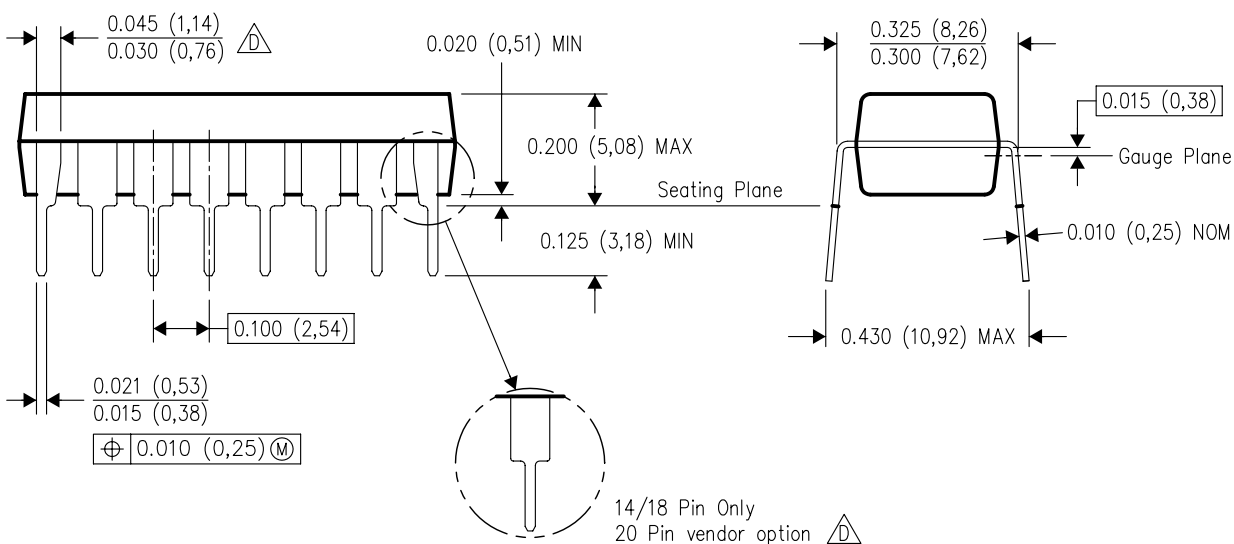
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |

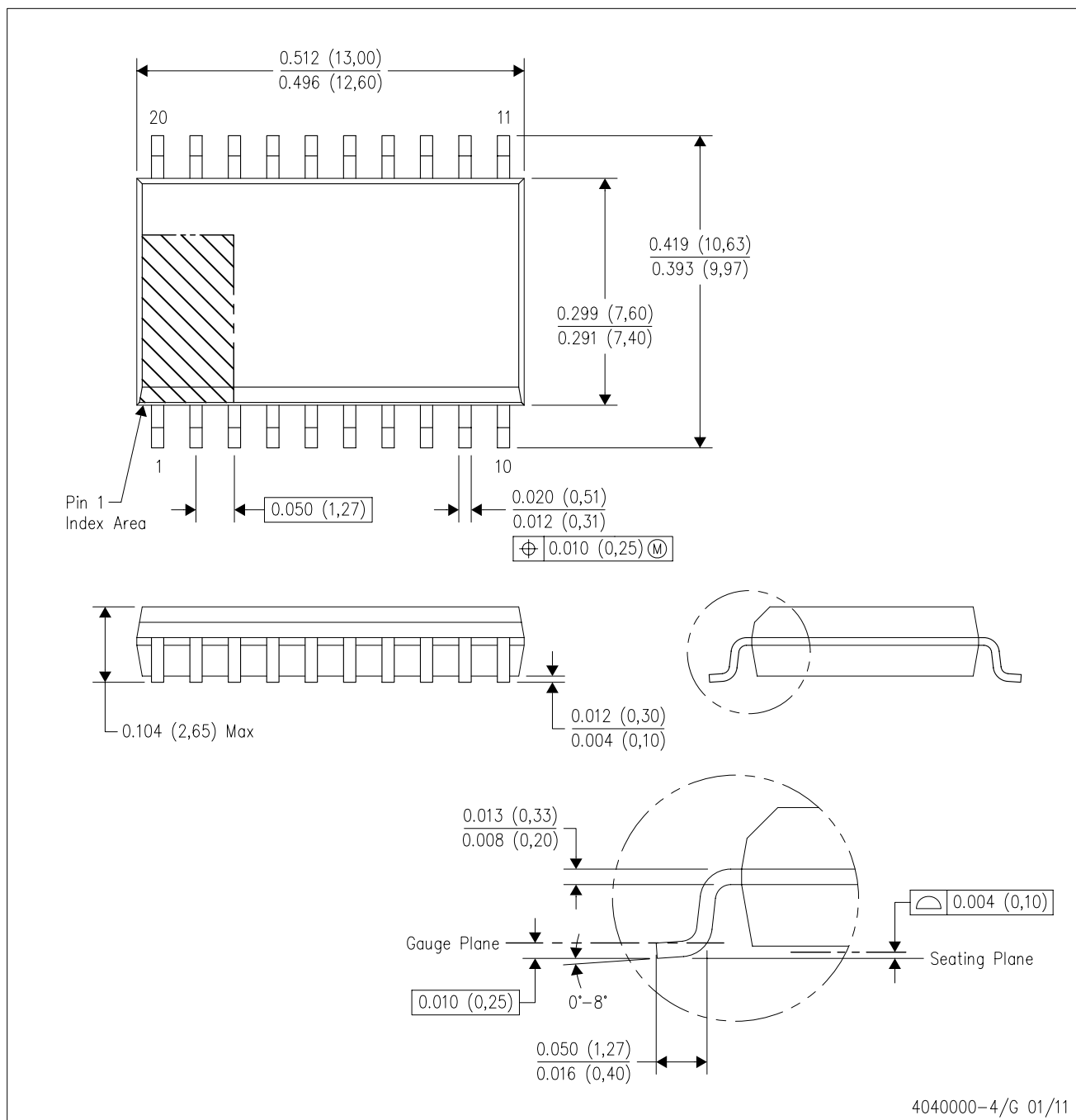


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G20)

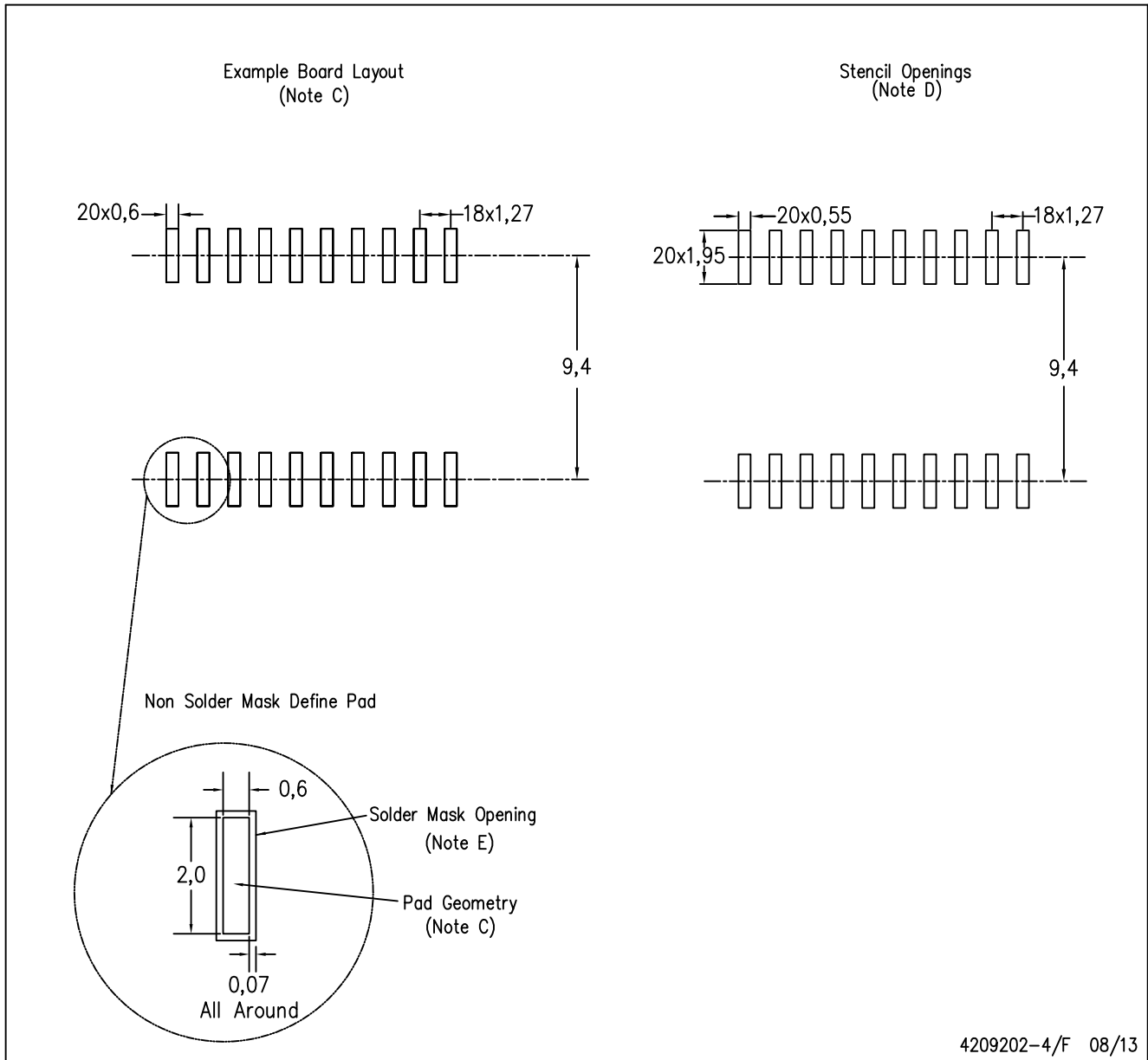
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AC.

DW (R-PDSO-G20)

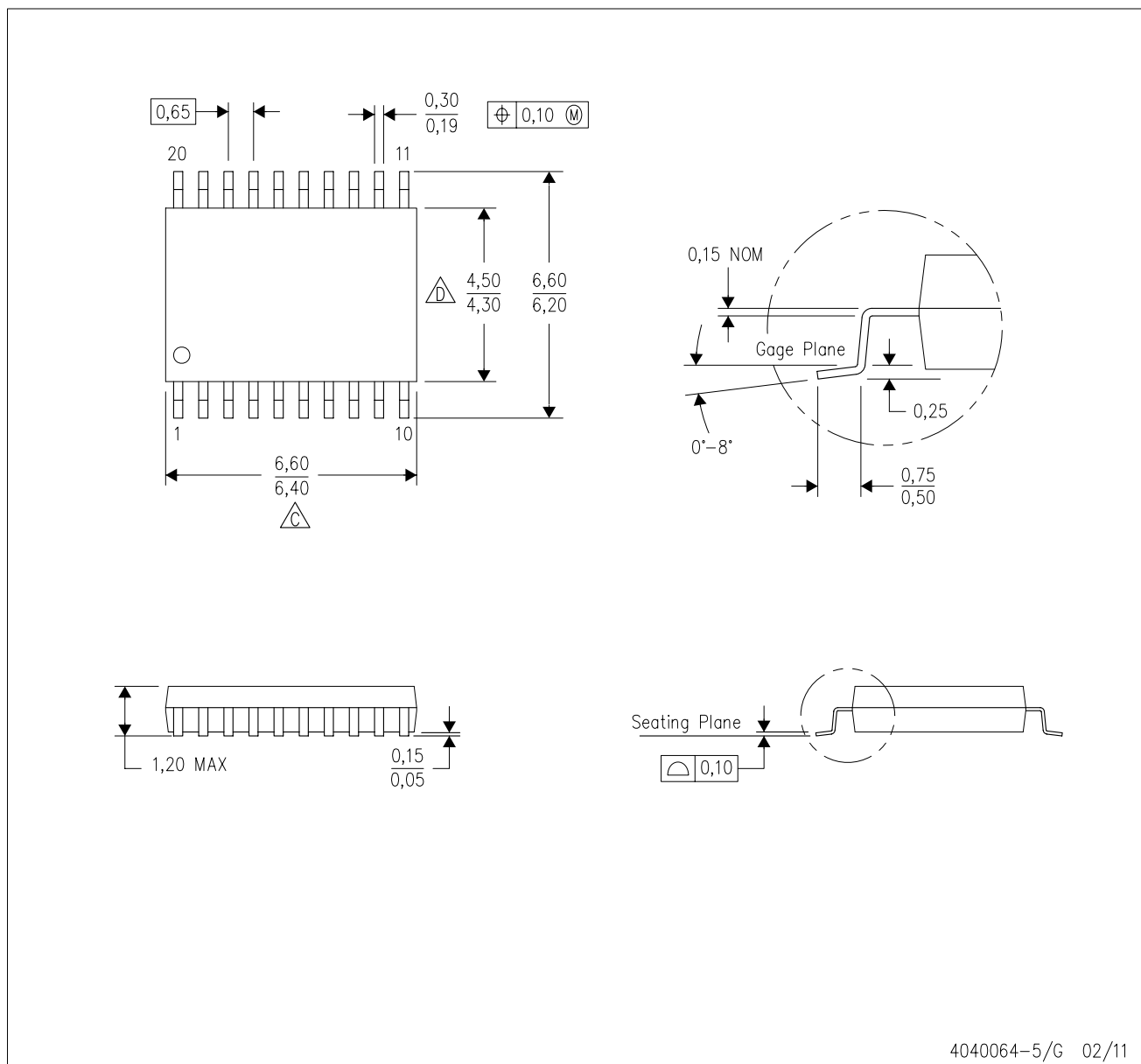
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



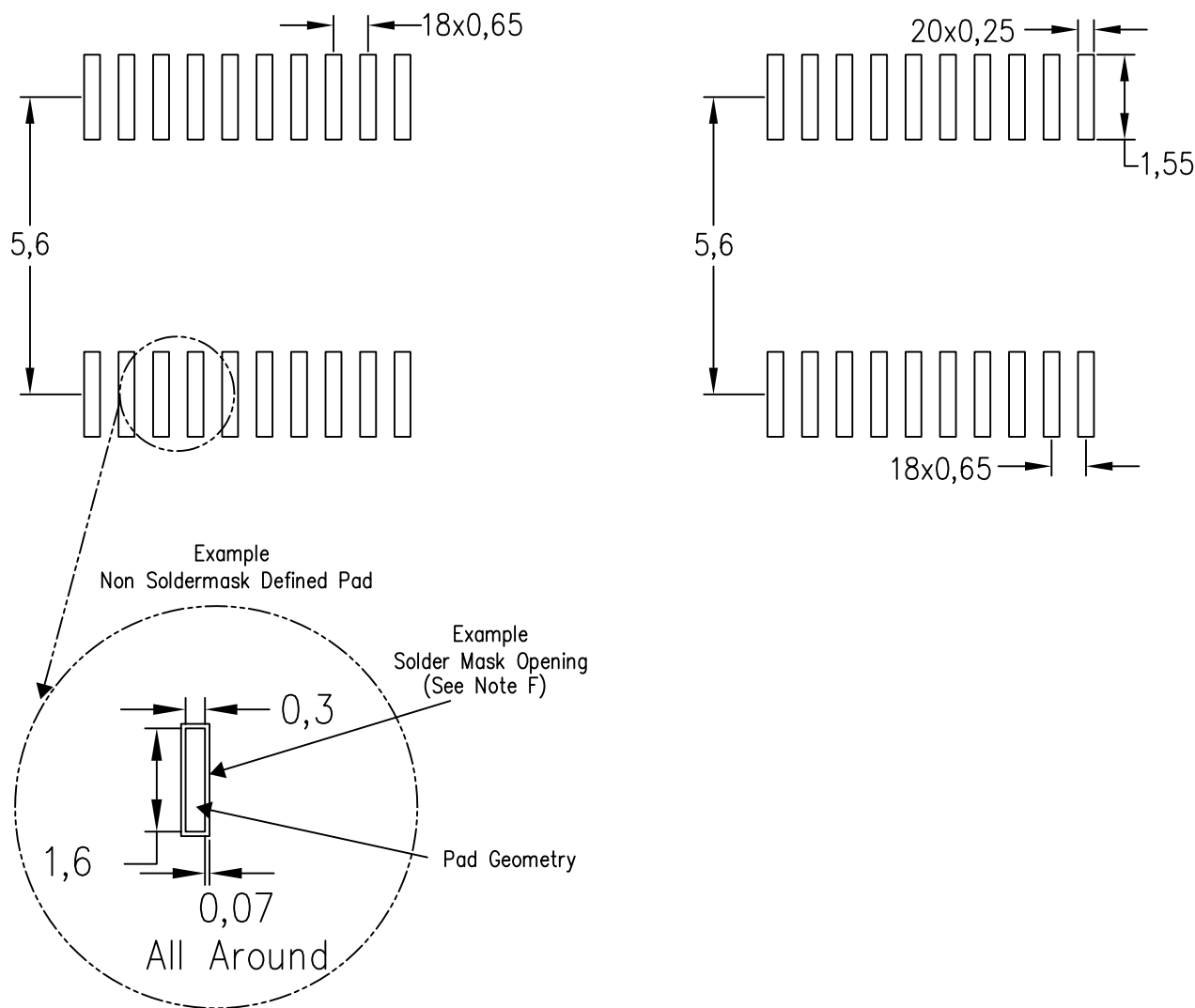
- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE

Example Board Layout

Based on a stencil thickness  
of .127mm (.005inch).



4211284-5/F 12/12

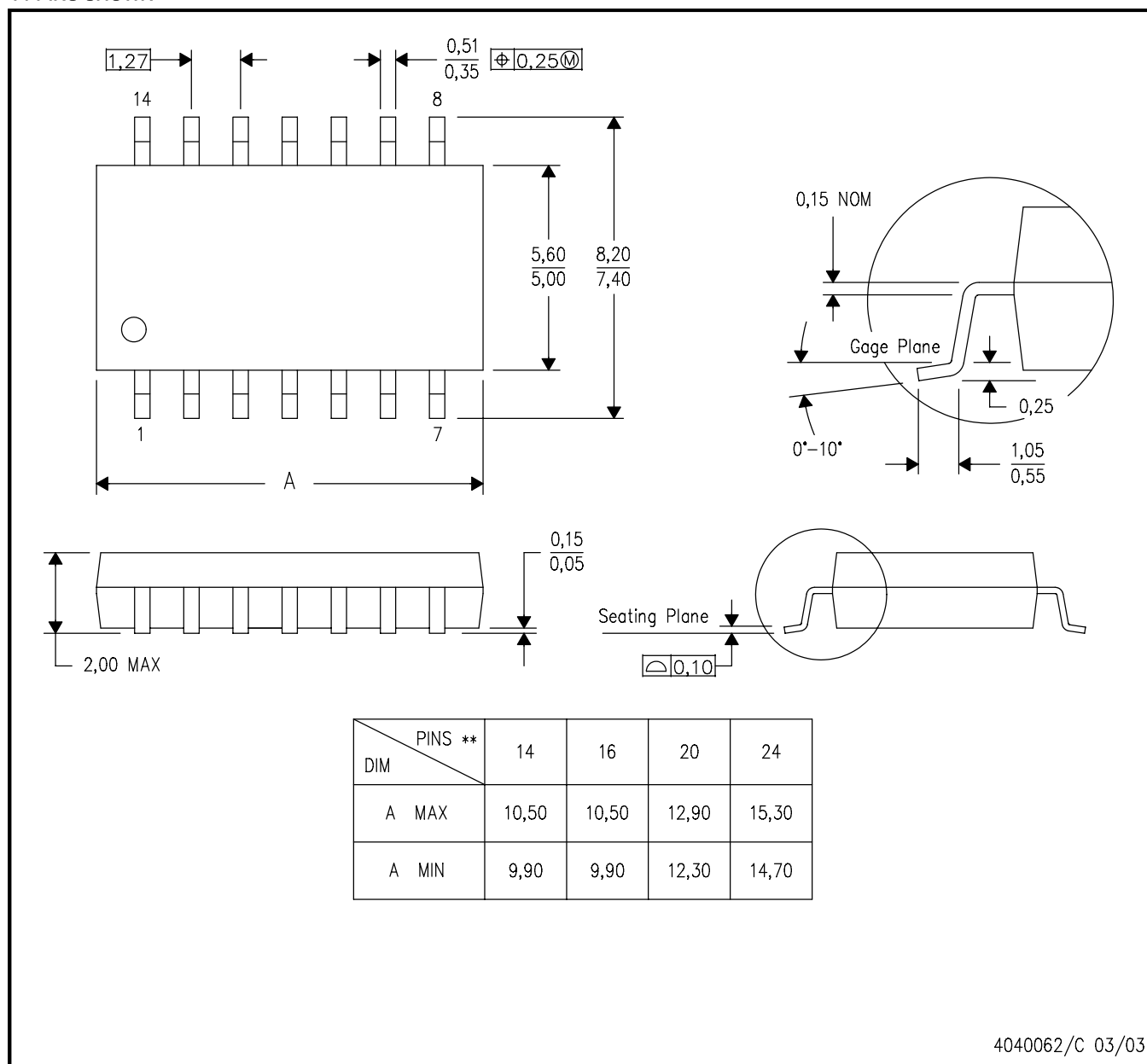
- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

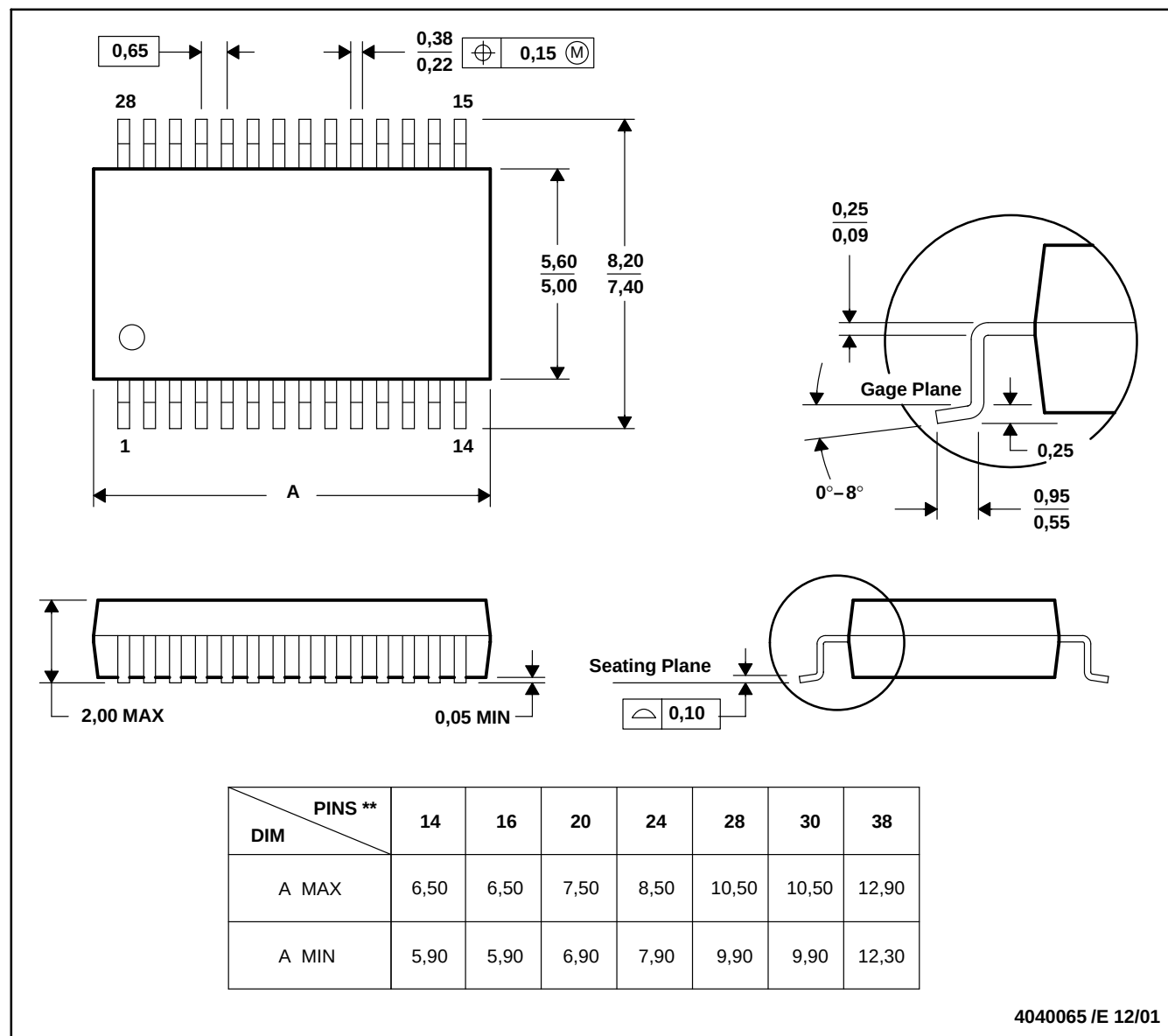


- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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